

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : **Confirmation No. 1659**
Tadashi MAEDA et al. : Attorney Docket No. 2006_1151A
Serial No. 10/586,598 : Group Art Unit 1793
Filed July 20, 2006 : Examiner Megha S. Mehta
FLUX FOR SOLDERING AND : **Mail Stop: AMENDMENT**
SOLDERING PROCESS

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action of October 2, 2009, please amend the above-identified application as follows:

The Commissioner is authorized to charge any deficiency or to credit any overpayment associated with this communication to Deposit Account No. 23-0975, with the EXCEPTION of deficiencies in fees for multiple dependent claims in new applications.